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• 5 linear traps tested in 3 different groups with Ca⁺ and Yb⁺ [arXiv:1008.0990v1].

4 level metal

Development - Four metal layer process:

- Routing of RF and Crossing of DC electrodes is required away from trapping regions
- Allows for interior RF/DC electrodes to be wired (e.g. ring trap)
- Simplifies simulations by eliminated need to model effect of leads



On chip capacitors



• Higher capacitance density for trench capacitors (94.3 $fF/\mu m^2$ vs. 1.3 fF/ μ m²).

• Capacitors are located within microns of DC electrode.

• 1nF trench capacitor is about

the size of an electrode



Microfabricated Surface Electrode Ion Traps

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Precision dielectric set-back



bonding minimize interference with lasers

- Trapped single and multiple ions
- Shuttled ion single axis (830 μm) 10⁵ repeat fidelity
- Shuttled to each leg of junction 10⁶ times without ion loss
- Successful junction shuttling in two different Y-junction models



Time lapse image in the junction - a single ion moving up each leg



Ring Traps and Cavity QED – MQCO collaboration



- Can realize transmissive and/or reflective integrated optics
- Off-axis capability \rightarrow dense optic arrays with 100% fill factor
- Entire lens set is aligned to ions and in-vacuum fiber connector
- Maximum photon interaction in a simple, robust configuration





- loading hole is illuminated by the oven

Integrated Diffractive and Micro Optics



Sandia DOE array in fused silica with 100% fill-factor **Optical microscope (L) and SEM (R) images**

Milestones

• Fabricated 8-level F/1 lenses with focused spot diameters < 1micron at 397 nm Multi-fiber feed-throughs and in-vacuum connectors survive bake-out and maintain ultra-high vacuum







With 4 metal levels, all electrode routing will be invisible to ion.



designed for cavity thru-hole Mount registered to Si chip • Goal of $C_1 > 0.2$ for Yb⁺ and 10% light collection efficiency





Existing Sandia Capabilities

• Diffractive Optical Element (DOE) arrays in fused silica with 100% fill factor Fused silica and lithium fluoride polarizers with extinction ratios > 100:1 Microwaveplates with 9.4° rms variation across broad MWIR band





G.R. Brady et al. arXiv:1008.2977v1